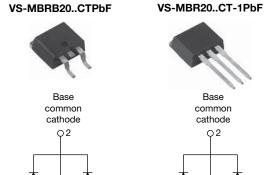
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Schottky Rectifier, 2 x 10 A

Common O

cathode Anode



D²PAK TO-262

Anode

Common C

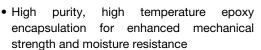
cathode Anode

Anode

PRODUCT SUMMARY				
Package	TO-263AB (D ² PAK), TO-262AA			
I _{F(AV)}	2 x 10 A			
V_{R}	35 V, 45 V			
V _F at I _F	0.72 V			
I _{RM} max.	15 mA at 125 °C			
T _J max.	150 °C			
Diode variation	Common cathode			
E _{AS}	8 mJ			

FEATURES

- 150 °C T_J operation
- Center tap D2PAK and TO-262 packages
- Low forward voltage drop
- High frequency operation





ROHS COMPLIANT HALOGEN FREE

- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS Directive 2002/95/EC
- AEC-Q101 qualified

DESCRIPTION

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	VALUES	UNITS		
I _{F(AV)}	Rectangular waveform (per device)	20	٨		
I _{FRM}	T _C = 135 °C (per leg)	20	А		
V _{RRM}		35/45	V		
I _{FSM}	t _p = 5 µs sine	1060	Α		
V _F	10 Apk, T _J = 125 °C	0.57	V		
T _J	Range	- 65 to 150	°C		

VOLTAGE RATINGS					
PARAMETER	SYMBOL	VS-MBRB2035CTPbF VS-MBR2035CT-1PbF	VS-MBRB2045CTPbF VS-MBR2045CT-1PbF	UNITS	
Maximum DC reverse voltage	V_{R}	35	45	V	
Maximum working peak reverse voltage	V_{RWM}	33	43	V	



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ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	7	TEST CONDITIONS	VALUES	UNITS	
Maximum average per leg	I	T _C = 135 °C, rate	d V-	10		
forward current per device	I _{F(AV)}	1 _C = 133 O, Tate	u v _R	20		
Peak repetitive forward current per leg	I _{FRM}	Rated V _R , square	Rated V _R , square wave, 20 kHz, T _C = 135 °C		_	
		5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated V _{RRM} applied	1060	A	
Non-repetitive peak surge current	IFSM	Surge applied at single phase, 60	rated load conditions halfwave, Hz	150		
Non-repetitive avalanche energy per leg	E _{AS}	T _J = 25 °C, I _{AS} = 2 A, L = 4 mH		8	mJ	
Repetitive avalanche current per leg	I _{AR}	Current decaying Frequency limited V _A = 1.5 x V _R typi	, ,	2	А	

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS
		20 A	T _J = 25 °C	0.84	
Maximum forward voltage drop	V _{FM} ⁽¹⁾	10 A	T _J = 125 °C	0.57	V
		20 A	1 1J = 125 C	0.72	
Maximum instantaneous	I _{RM} ⁽¹⁾	T _J = 25 °C	Rated DC voltage	0.1	- mA
reverse current	IRM (1)	T _J = 125 °C	hated DC voltage	15	
Threshold voltage	V _{F(TO)}	T T manyimayan		0.354	V
Forward slope resistance	r _t	$T_J = T_J$ maximum		17.6	mΩ
Maximum junction capacitance	C _T	V _R = 5 V _{DC} (test signal rang	ge 100 kHz to 1 MHz), 25 °C	600	pF
Typical series inductance	L _S	Measured from top of terminal to mounting plane		8.0	nH
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs

Note

 $^{^{(1)}\,}$ Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHNICAL SE	PECIFICA	TIONS			
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction temperature range	T_J		- 65 to 150	°C	
Maximum storage temperature range	T _{Stg}		- 65 to 175		
Maximum thermal resistance, junction to case per leg	R _{thJC}	DC operation	2.0	°C/W	
Typical thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth and greased	0.50	C/VV	
A			2	g	
Approximate weight			0.07	OZ.	
Mounting torque		Non-lubricated threads	6 (5)	kgf · cm	
Mounting torque maximum		Non-lubricated tifreads	12 (10)	(lbf · in)	
		G TO 0004D (D2D40)	MBRB2	2035CT	
Marking device		Case style TO-263AB (D ² PAK)	MBRB2	MBRB2045CT	
		Coop at the TO 2024A	MBR20	35CT-1	
		Case style TO-262AA	MBR20	MBR2045CT-1	



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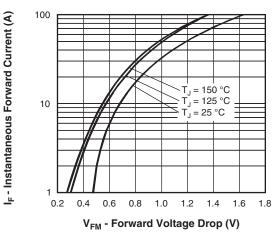


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

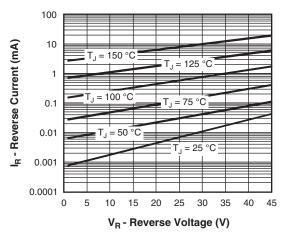


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

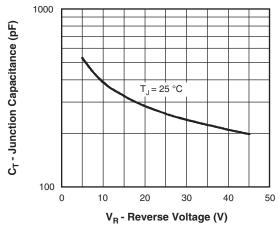


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

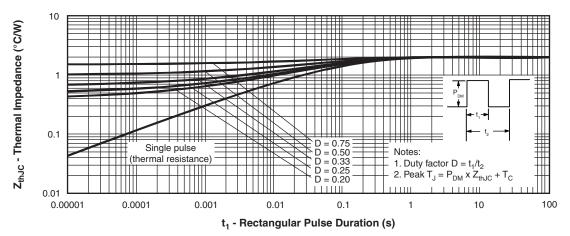


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)



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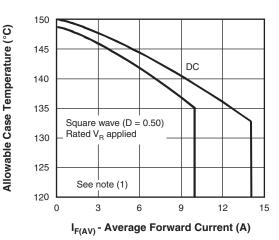


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

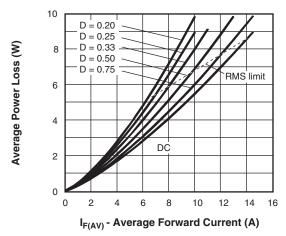
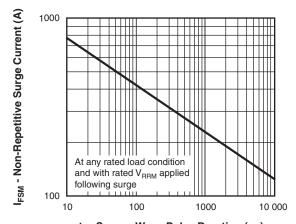


Fig. 6 - Forward Power Loss Characteristics (Per Leg)



 t_p - Square Wave Pulse Duration (μ s) Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

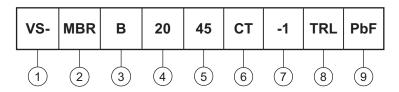
Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{Forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{Inverse power loss} = V_{R1} \times I_R \text{ (1 - D); } I_R \text{ at } V_{R1} = \text{Rated } V_R \\ \end{array}$

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Essential part number

3 - • B = D^2PAK 7 None

• None = TO-262 **7** = -1

- Current rating (20 = 20 A)

5 - Voltage ratings - 35 = 35 V 45 = 45 V

CT = Essential part number

- None = D^2PAK 3 = B

• -1 = TO-262 **3** None

8 - • None = Tube

• TRL = Tape and reel (left oriented - for D²PAK only)

• TRR = Tape and reel (right oriented - for D²PAK only)

9 - • PbF = Lead (Pb)-free (for TO-262 and D²PAK tube)

• P = Lead (Pb)-free (for D²PAK TRR and TRL)

ORDERING INFORMATION (Example)					
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION		
VS-MBRB2035CTPBF	50	1000	Antistatic plastic tube		
VS-MBR2035CT-1PBF	50	1000	Antistatic plastic tube		
VS-MBRB2035CTTRLP	800	800	13" diameter reel		
VS-MBRB2035CTTRRP	800	800	13" diameter reel		
VS-MBRB2045CTPBF	50	1000	Antistatic plastic tube		
VS-MBR2045CT-1PBF	50	1000	Antistatic plastic tube		
VS-MBRB2045CTTRLP	800	800	13" diameter reel		
VS-MBRB2045CTTRRP	800	800	13" diameter reel		

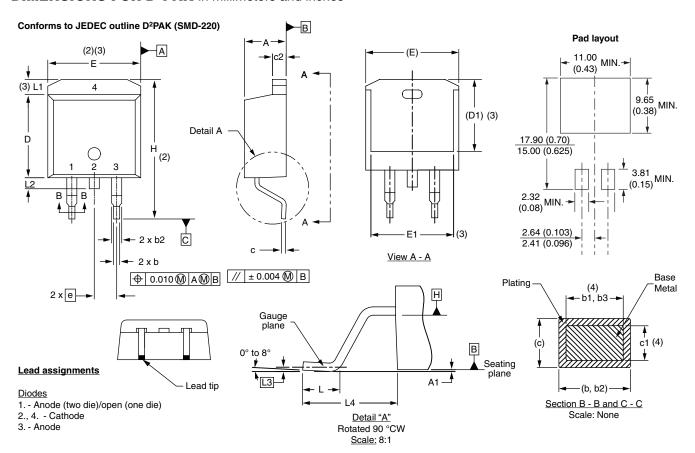
LINKS TO RELATED DOCUMENTS				
Dimensions www.vishay.com/doc?95014				
Part marking information	www.vishay.com/doc?95008			
Packaging information	www.vishay.com/doc?95032			
SPICE model	www.vishay.com/doc?95504			



Vishay High Power Products

D²PAK, TO-262

DIMENSIONS FOR D²PAK in millimeters and inches



0)////	MILLIM	MILLIMETERS		INCHES	
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- $^{(3)}\,$ Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch

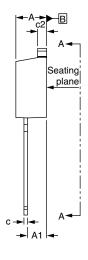
(7) Outline conforms to JEDEC outline TO-263AB

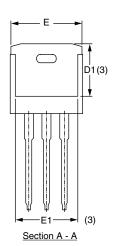
Vishay High Power Products

D²PAK, TO-262



DIMENSIONS FOR TO-262 in millimeters and inches





⊕ 0.010**⋒**|A**⋒**|B

Lead assignments

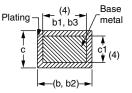


<u>Diodes</u>

-3 x b2 --3 x b

> 1. - Anode (two die)/open (one die) 2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

SYMBOL	MILLIN	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.06	4.83	0.160	0.190		
A1	2.03	3.02	0.080	0.119		
b	0.51	0.99	0.020	0.039		
b1	0.51	0.89	0.020	0.035	4	
b2	1.14	1.78	0.045	0.070		
b3	1.14	1.73	0.045	0.068	4	
С	0.38	0.74	0.015	0.029		
c1	0.38	0.58	0.015	0.023	4	
c2	1.14	1.65	0.045	0.065		
D	8.51	9.65	0.335	0.380	2	
D1	6.86	8.00	0.270	0.315	3	
E	9.65	10.67	0.380	0.420	2, 3	
E1	7.90	8.80	0.311	0.346	3	
е	2.54 BSC		0.10	0 BSC		
L	13.46	14.10	0.530	0.555		
L1	-	1.65	-	0.065	3	
L2	3.56	3.71	0.140	0.146		

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches

(6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline



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Vishay

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